1. General description

Trench Maximum Efficiency General Application (MEGA) Schottky barrier rectifier encapsulated in a CFP3 (SOD123W) small and flat lead Surface-Mounted Device (SMD) plastic package.

2. Features and benefits

- Average forward current: I_{F(AV)} ≤ 3 A
- Reverse voltage: V_R ≤ 40 V
- Low forward voltage
- Low leakage current due to Trench MEGA Schottky technology
- High power capability due to clip-bonding technology
- Small and flat lead SMD plastic package
- · Suitable for both reflow and wave soldering
- Qualified according to AEC-Q101 and recommended for use in automotive applications

3. Applications

- · Low voltage rectification
- · High efficiency DC-to-DC conversion
- · Switch mode power supply
- · Freewheeling application
- Reverse polarity protection
- · Low power consumption application

4. Quick reference data

Table 1. Quick reference data

Symbol	Parameter	Conditions		Min	Тур	Max	Unit
I _{F(AV)}	average forward current	δ = 0.5; f = 20 kHz; square wave; T _{sp} \leq 150 °C		-	-	3	Α
V_R	reverse voltage	T _j = 25 °C		-	-	40	V
V_{F}	forward voltage	I _F = 3 A; T _j = 25 °C; pulsed	[1]	-	460	525	mV
I_R	reverse current	V _R = 10 V; T _j = 25 °C; pulsed	[1]	-	5	16	μA
		$V_R = 40 \text{ V}; T_j = 25 \text{ °C}; \text{ pulsed}$	[1]	-	8	28	μΑ

[1] Very short pulse, in order to maintain a stable junction temperature.



5. Pinning information

Table 2. Pinning information

Pin	Symbol	Description	Simplified outline	Graphic symbol
1	K	cathode		К .[К.] -А
2	А	anode	CFP3 (SOD123W)	sym001

6. Ordering information

Table 3. Ordering information

Type number	Package		
	Name	Description	Version
PMEG40T30ER-Q	CFP3	plastic, surface mounted package; 2 terminals; 2.6 mm x 1.7 mm x 1 mm body	SOD123W

7. Marking

Table 4. Marking codes

Type number	Marking code
PMEG40T30ER-Q	L5

8. Limiting values

Table 5. Limiting values

In accordance with the Absolute Maximum Rating System (IEC 60134).

Symbol	Parameter	Conditions		Min	Max	Unit
V_R	reverse voltage	T _j = 25 °C		-	40	V
l _F	forward current	δ = 1; $T_{sp} \le 145 ^{\circ}\text{C}$		-	4.2	А
I _{F(AV)}	average forward current	δ = 0.5; f = 20 kHz; square wave; $T_{sp} \le$ 150 °C		-	3	A
I _{FSM}	non-repetitive peak forward current	t_p = 8 ms; square wave; $T_{j(init)}$ = 25 °C		-	40	А
P _{tot}	total power dissipation	T _{amb} ≤ 25 °C	[1]	-	0.68	W
			[2]	-	1.15	W
Tj	junction temperature			-	175	°C
T _{amb}	ambient temperature			-55	175	°C
T _{stg}	storage temperature			-65	175	°C

^[1] Device mounted on an FR4 Printed-Circuit Board (PCB), single-sided copper, tin-plated and standard footprint.

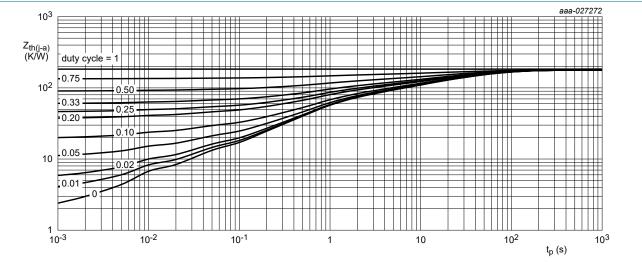
^[2] Device mounted on an FR4 PCB, single-sided copper, tin-plated, mounting pad for cathode 1 cm².

9. Thermal characteristics

Table 6. Thermal characteristics

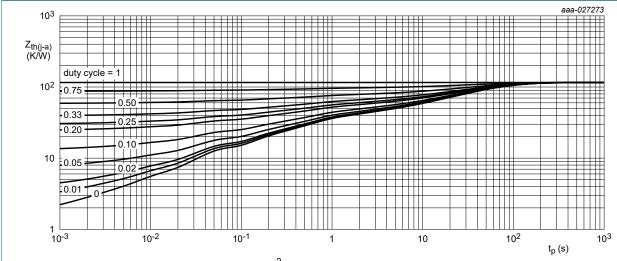
Symbol	Parameter	Conditions		Min	Тур	Max	Unit
ui(j-a)	thermal resistance from	in free air	[1] [2]	-	-	220	K/W
	junction to ambient		[1] [3]	-	-	130	K/W
R _{th(j-sp)}	thermal resistance from junction to solder point		[4]	-	-	18	K/W

- [1] For Schottky barrier diodes thermal runaway has to be considered, as in some applications the reverse power losses P_R are a significant part of the total power losses.
- [2] Device mounted on an FR4 PCB, single-sided copper, tin-plated and standard footprint.
- [3] Device mounted on an FR4 PCB, single-sided copper, tin-plated, mounting pad for cathode 1 cm².
- [4] Soldering point of cathode tab.



FR4 PCB, standard footprint

Fig. 1. Transient thermal impedance from junction to ambient as a function of pulse duration; typical values



FR4 PCB, mounting pad for cathode 1 cm²

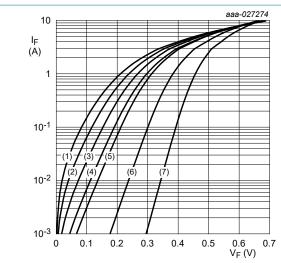
Fig. 2. Transient thermal impedance from junction to ambient as a function of pulse duration; typical values

10. Characteristics

Table 7. Characteristics

Symbol	Parameter	Conditions		Min	Тур	Max	Unit
$V_{(BR)R}$	reverse breakdown voltage	I_R = 1 mA; pulsed; T_j = 25 °C	[1]	40	-	-	V
V _F	forward voltage	I _F = 0.1 A; T _j = 25 °C; pulsed	[1]	-	300	345	mV
		I _F = 1 A; T _j = 25 °C; pulsed	[1]	-	380	440	mV
		I _F = 2 A; T _j = 25 °C; pulsed	[1]	-	425	490	mV
		I _F = 3 A; T _j = 25 °C; pulsed	[1]	-	460	525	mV
		I _F = 3 A; T _j = -40 °C; pulsed	[1]	-	515	-	mV
		I _F = 3 A; T _j = 125 °C; pulsed	[1]	-	380	-	mV
I _R	reverse current	V _R = 10 V; T _j = 25 °C; pulsed	[1]	-	5	16	μΑ
		V _R = 30 V; T _j = 25 °C; pulsed	[1]	-	7	-	μΑ
		V _R = 40 V; T _j = 25 °C; pulsed	[1]	-	8	28	μΑ
		V _R = 40 V; T _j = 125 °C; pulsed	[1]	-	5.5	-	mA
C _d	diode capacitance	V _R = 1 V; f = 1 MHz; T _j = 25 °C		-	560	-	pF
		V _R = 10 V; f = 1 MHz; T _j = 25 °C		-	240	-	pF
t _{rr}	reverse recovery time step recovery	$I_F = 0.5 \text{ A}; I_R = 0.5 \text{ A}; I_{R(meas)} = 0.1 \text{ A};$ $T_j = 25 \text{ °C}$		-	18	-	ns
	reverse recovery time ramp recovery	$dI_F/dt = 200 \text{ A/}\mu\text{s}; I_F = 6 \text{ A}; V_R = 26 \text{ V};$ $T_j = 25 ^{\circ}\text{C}$		-	12	-	ns
V_{FRM}	peak forward recovery voltage	$I_F = 0.5 \text{ A}; dI_F/dt = 20 \text{ A/}\mu\text{s}; T_j = 25 ^{\circ}\text{C}$		-	390	-	mV

^[1] Very short pulse, in order to maintain a stable junction temperature.



pulsed condition

 $(1) T_i = 175 °C$

 $(2) T_i = 150 °C$

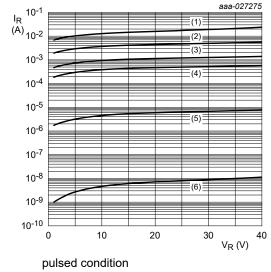
 $(3) T_i = 125 °C$

 $(4) T_j = 100 °C$

(5) $T_j = 85 ^{\circ}C$ (6) $T_i = 25 ^{\circ}C$

 $(7) T_i = -40 ^{\circ}C$

Fig. 3. Forward current as a function of forward voltage; typical values



(1) $T_i = 150 \, ^{\circ}\text{C}$

(2) $T_i = 125 °C$

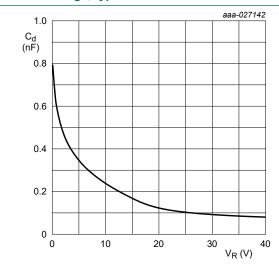
 $(3) T_j = 100 °C$

 $(4) T_i = 85 °C$

(5) $T_j = 25 \,^{\circ}\text{C}$

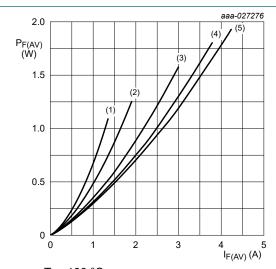
(6) $T_j = -40 \, ^{\circ}\text{C}$

Fig. 4. Reverse current as a function of reverse voltage; typical values



f = 1 MHz; T_{amb} = 25 °C

Fig. 5. Diode capacitance as a function of reverse voltage; typical values



T_j = 100 °C

 $(1) \delta = 0.1$

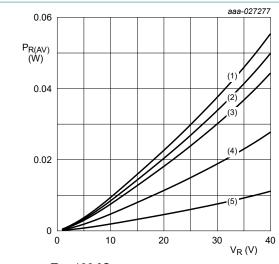
 $(2) \delta = 0.2$

 $(3) \delta = 0.5$

 $(4) \delta = 0.8$

(5) $\delta = 1$; DC

Fig. 6. Average forward power dissipation as a function of average forward current; typical values



 $T_j = 100 \,{}^{\circ}C$

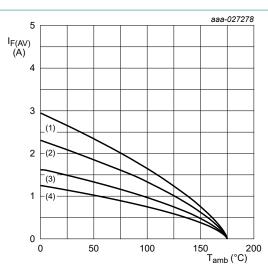
 $(1) \delta = 1; DC$

 $(2) \delta = 0.9$

 $(3) \delta = 0.8$

 $(4) \delta = 0.5$ (5) $\delta = 0.2$

Fig. 7. Average reverse power dissipation as a function of reverse voltage; typical values



FR4 PCB, standard footprint

 $T_i = 175 \,{}^{\circ}\text{C}$

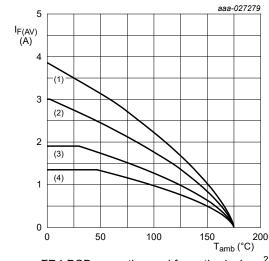
 $(1) \delta = 1; DC$

(2) $\delta = 0.5$; f = 20 kHz

(3) $\delta = 0.2$; f = 20 kHz

(4) $\delta = 0.1$; f = 20 kHz

Fig. 8. Average forward current as a function of ambient temperature; typical values



FR4 PCB, mounting pad for cathode 1 cm²

T_i = 175 °C

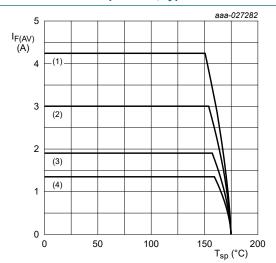
 $(1) \delta = 1$; DC

(2) $\delta = 0.5$; f = 20 kHz

(3) $\delta = 0.2$; f = 20 kHz

(4) $\delta = 0.1$; f = 20 kHz

Fig. 9. Average forward current as a function of ambient temperature; typical values



 $T_i = 175 \,{}^{\circ}\text{C}$

 $(1) \delta = 1; DC$

(2) δ = 0.5; f = 20 kHz

(3) $\delta = 0.2$; f = 20 kHz

(4) $\delta = 0.1$; f = 20 kHz

Fig. 10. Average forward current as a function of solder point temperature; typical values

11. Test information

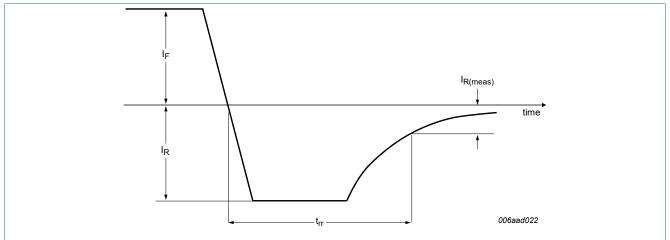


Fig. 11. Reverse recovery definition; step recovery

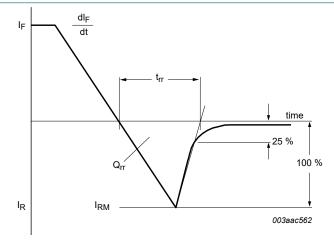


Fig. 12. Reverse recovery definition; ramp recovery

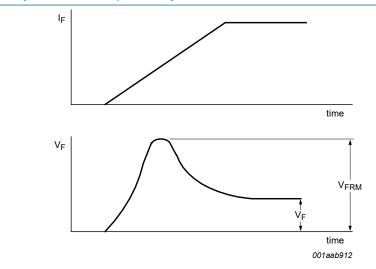
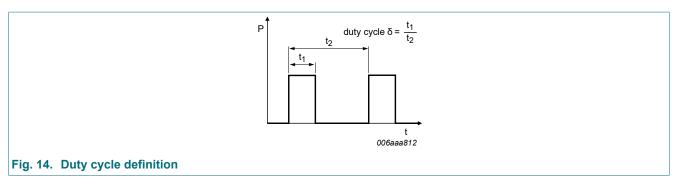


Fig. 13. Forward recovery definition



The current ratings for the typical waveforms are calculated according to the equations:

 $I_{F(AV)} = I_M \times \delta$ with I_M defined as peak current

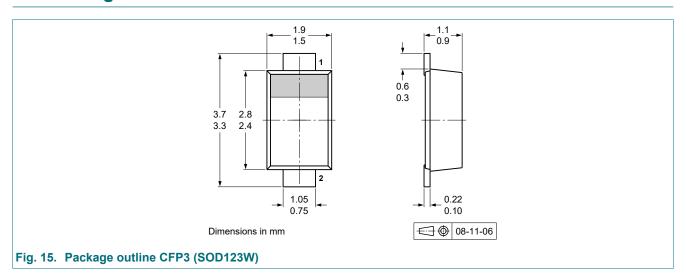
 $I_{RMS} = I_{F(AV)}$ at DC, and $I_{RMS} = I_{M} \times \sqrt{\delta}$

with I_{RMS} defined as RMS current.

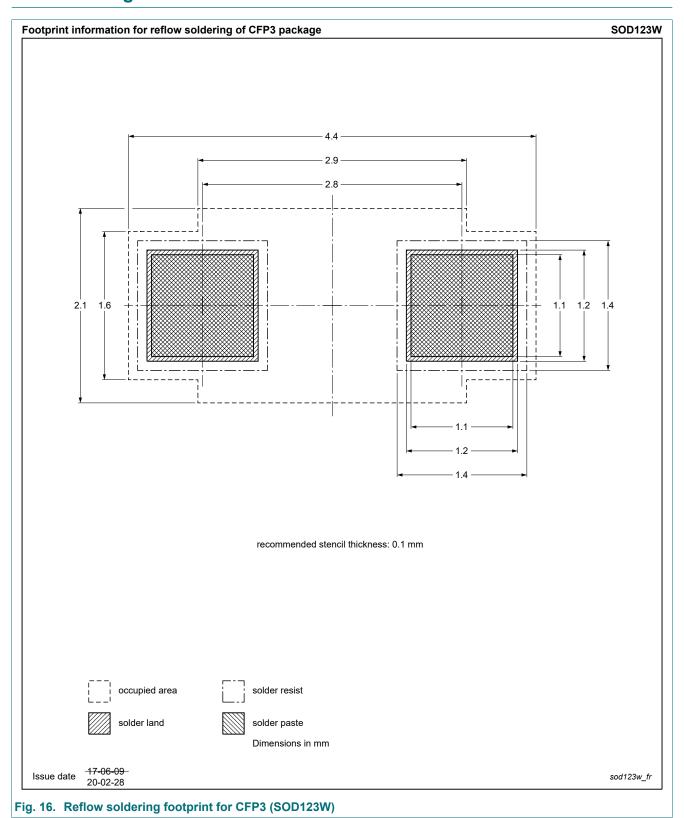
Quality information

This product has been qualified in accordance with the Automotive Electronics Council (AEC) standard Q101 - Stress test qualification for discrete semiconductors, and is suitable for use in automotive applications.

12. Package outline



13. Soldering



PMEG40T30ER-Q

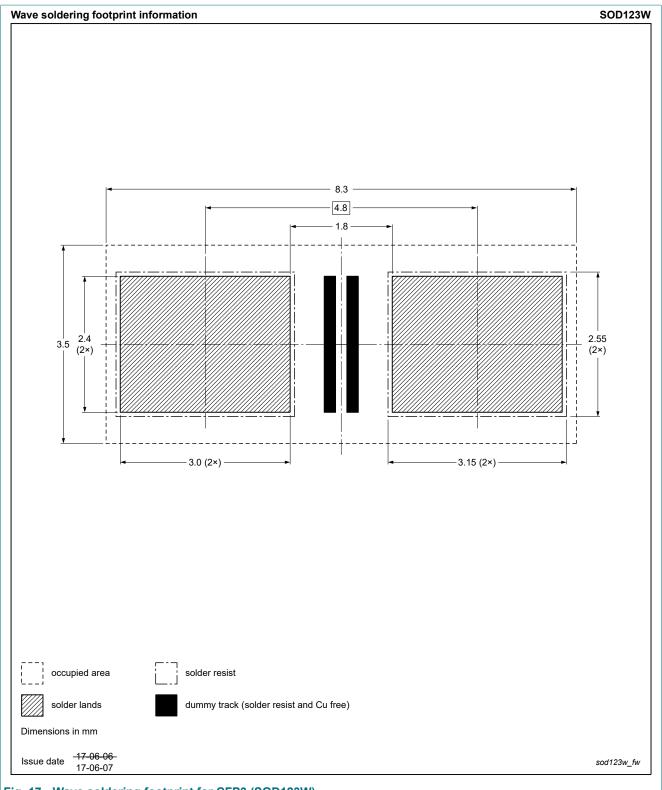


Fig. 17. Wave soldering footprint for CFP3 (SOD123W)

14. Revision history

Table 8. Revision history

Data sheet ID	Release date	Data sheet status	Change notice	Supersedes
PMEG40T30ER-Q v.1	20211110	Product data sheet	-	-

15. Legal information

Data sheet status

Document status [1][2]	Product status [3]	Definition
Objective [short] data sheet	Development	This document contains data from the objective specification for product development.
Preliminary [short] data sheet	Qualification	This document contains data from the preliminary specification.
Product [short] data sheet	Production	This document contains the product specification.

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40 V, 3 A low Trench MEGA Schottky barrier rectifier

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